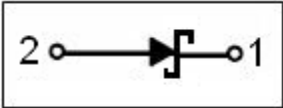


/ Descriptions

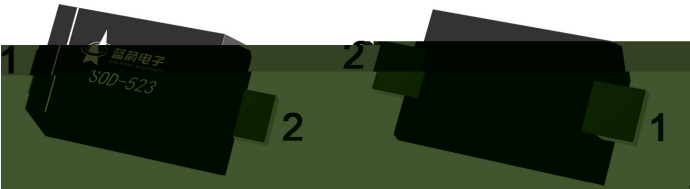
/ Features

/ Applications

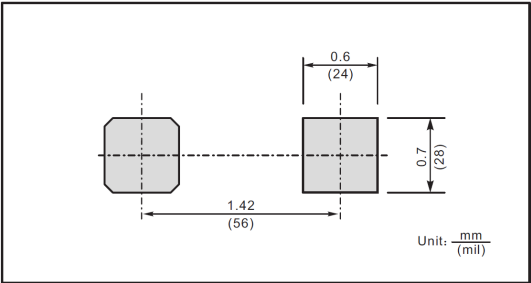
/ Equivalent Circuit



/ Pinning



The recommended mounting pad size



/ Marking

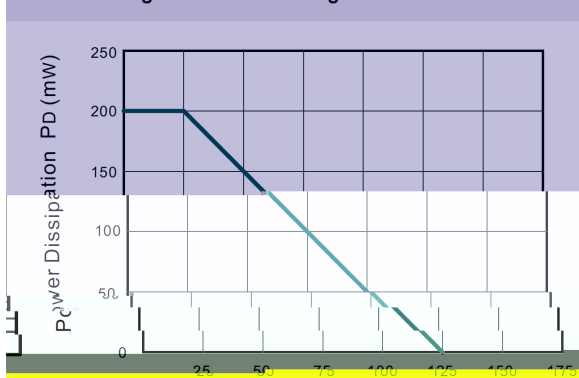
/ Absolute Maximum Ratings(Ta=25)

/ Electrical Characteristics(Ta=25)

		μ				
						μ

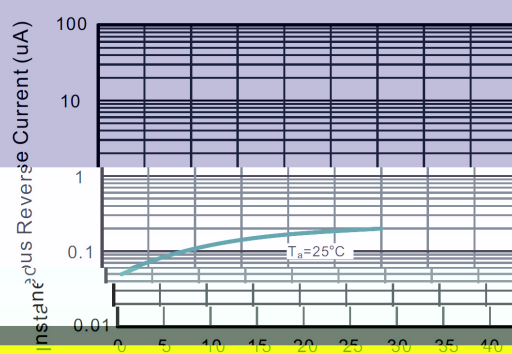
/ Electrical Characteristic Curve

Fig.1. Power Derating Curve



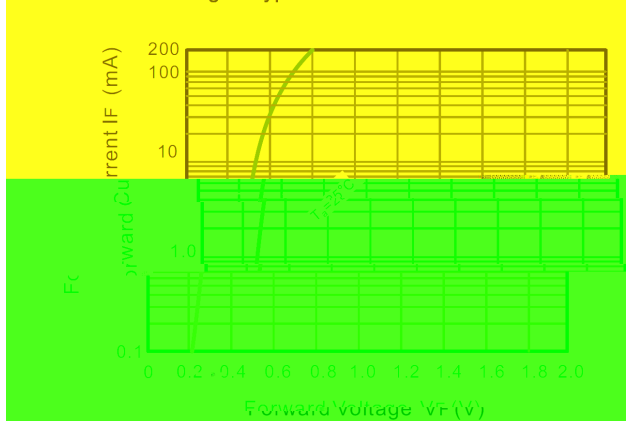
环境温度与功率耗散关系图

Fig.2 Typical Instantaneous Reverse Characteristics



典型瞬态反向特性图

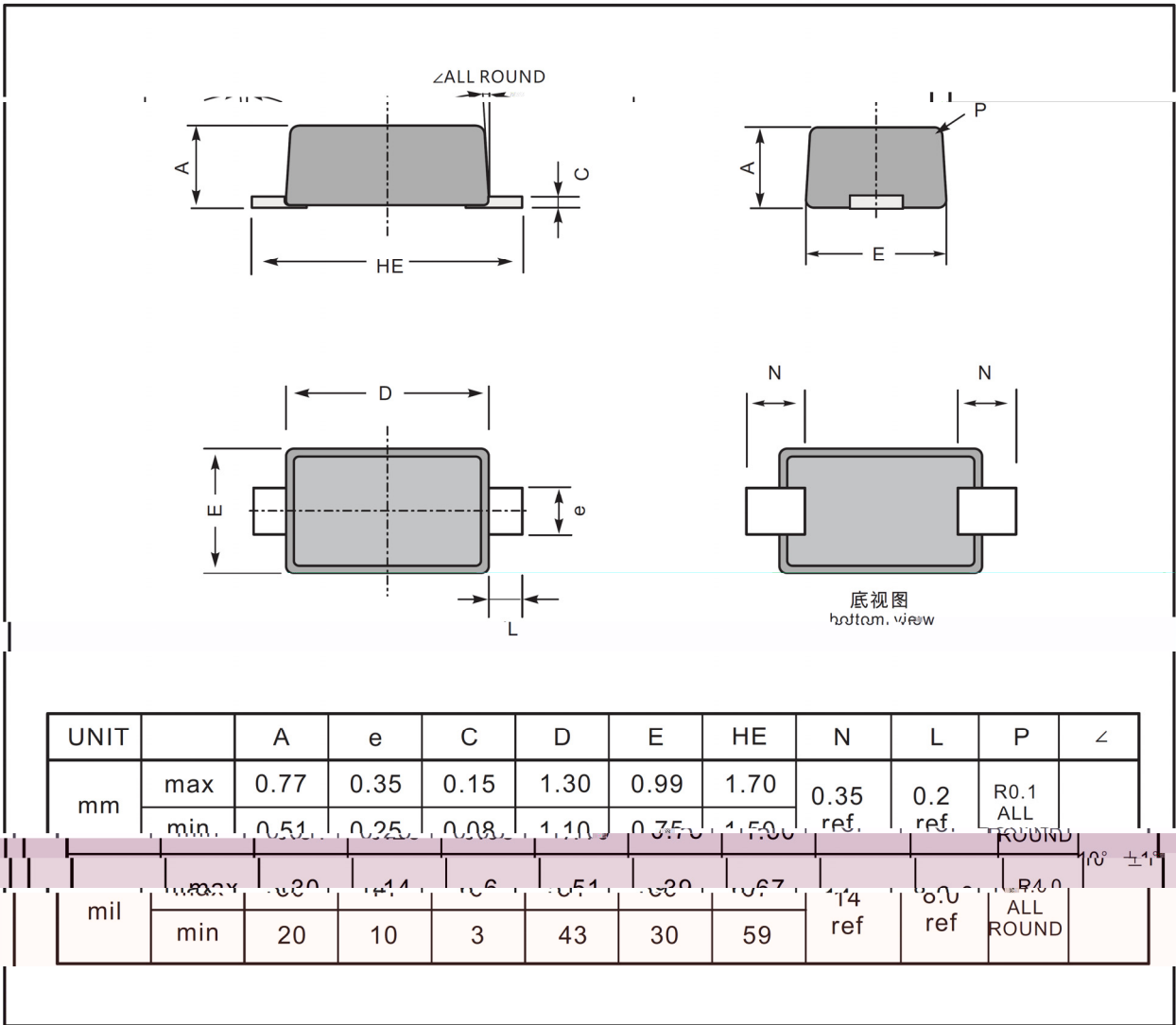
Fig.3 Typical Forward Characteristics



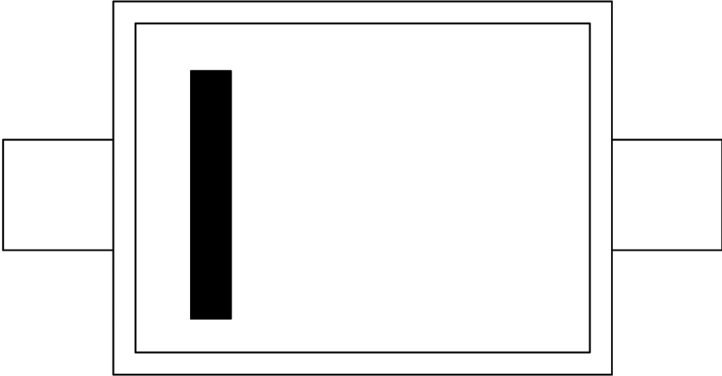
正向特性图

/ Package Dimensions

SOD-523

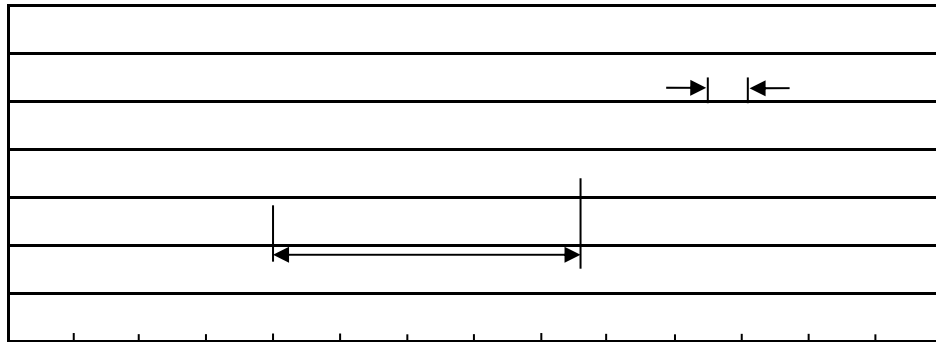


/ Marking Instructions



C

() /


$$\pm \qquad \qquad \qquad \pm \qquad \qquad \qquad \pm \qquad \qquad \qquad \pm$$

/ Resistance to Soldering Heat Test Conditions

$$\pm \qquad \qquad \qquad \pm$$

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱

/ Notices